

02-23-1999

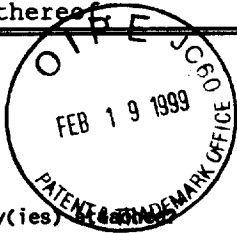
MRO  
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Attorney Docket No.: P63230US0

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.



1. Name of conveying party(ies):

Hyung Sup Yoon, Jin Hee Lee  
Byung Sun Park, Chul Soon Park  
Kwang Eui Pyun

Additional name(s) of conveying party(ies):

Yes  No

2. Name and address of receiving party(ies):

ELECTRONICS AND TELECOMMUNICATIONS RESEARCH INSTITUTE

Internal Address: \_\_\_\_\_

Street Address: 161 Kajong-dong, Yusong-gu

City: Taejon State: Korea ZIP: \_\_\_\_\_

Add'l name(s) & address(es) attached?  Yes  No

3. Nature of conveyance:

Assignment  Merger  
 Security Agreement  Change of Name  
 Other \_\_\_\_\_

Execution Dates: December 1, 1998

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)  
09/207,512, filed December 9, 1998  
Additional numbers attached?  Yes  No

B. Patent No.(s)

VOE

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Yoon S. Ham, Esq.

Internal Address: \_\_\_\_\_

Street Address: Jacobson, Price, Holman & Stern, PLLC  
400 Seventh Street, N.W.

City: Washington State: DC Zip: 20004

6. Total number of applications and patents involved: ..... 1

7. Total fee (37 CFR 1.21(h))..... \$ 40.00

Enclosed  
 Authorized to be charged to deposit account

8. Deposit account number: 06-1358  
(Atty.Dkt.No. 11349-P63230US0)

02/22/1999 DMGUYEN 00000164 09207512

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40.00 DP

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Yoon S. Ham (Limited Recognition) 02/19/99  
Name of Person Signing Date

Yoon S. Ham  
Signature

Total number of pages including cover sheet, attachments and document: 3

2. Additional name and address of receiving party(ies):

KOREA TELECOM  
206, Jungja-Dong, Pundang-Gu  
Sungnam-Shi, Kyoungki-Do  
Korea

UNITED STATES OF AMERICA-ASSIGNMENT

(1-6) Insert Name(s) of Inventors

- (1) HYUNG SUP YOON
(2) JIN HEE LEE
(3) BYUNG SUN PARK
(4) CHUL SOON PARK
(5) KWANG EUI PYUN
(6)

In consideration of the sum of one dollar (\$1.00), and other good and valuable considerations paid to each of the undersigned, the receipt and sufficiency of which are hereby acknowledged, the undersigned agree(s) to assign, transfer and set over to

(7) Insert Name of assignee

- (7) ELECTRONICS AND TELECOMMUNICATIONS RESEARCH INSTITUTE
and KOREA TELECOM

(8) Insert Address of Assignee

- (8) of 161 Kajong-dong, Yusong-gu, Taejon, Korea and
206 Jungja-Dong, Pundang-Gu, Sungnam-Shi, Kyoungki-Do, Korea

(9) Insert Legal Entity and State or Country (e.g., a corporation or citizen of Japan)

- (9) of Republic of Korea
(hereinafter designated as the Assignee) the entire right, title and interest for the United States, its territories, dependencies and possessions, in the invention known as

(10) insert Identification of Invention, such as Title, Case Number or Foreign Application Number

- (10) METHOD OF FABRICATING COMPOUND SEMICONDUCTOR DEVICES USING LIFT-OFF OF INSULATING FILM

(11) Insert Date of Signing of Application, or filing date and Serial No., if known

- for which the undersigned has (have) executed an application for patent in the United States of America
(11) Said application having been executed/ filed on December 9, 1998 (and assigned Serial No 09/207,512)

1) The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing or divisional applications thereof and also to execute separate assignments in connection with such application as the Assignee may deem necessary or expedient.

2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or any continuing or divisional applications thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Union for Protection of Industrial Property or similar agreements.

4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States resulting from this application or any continuing or divisional applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

6) The undersigned hereby grant(s) the law firm of Jacobson, Price, Holman & Stern, 400 Seventh Street, N.W., Washington, D.C. 20004, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Table with 3 columns: Date, Name of Inventor, and Signature/Seal. Rows include: December 1, 1998, HYUNG SUP YOON; December 1, 1998, JIN HEE LEE; December 1, 1998, BYUNG SUN PARK; December 1, 1998, CHUL SOON PARK; December 1, 1998, KWANG EUI PYUN; and two empty rows.

This assignment should preferably be signed before a United States Consul if signed abroad, or a Notary public if domestically signed. If not, then the execution by the inventor(s) should be witnessed by at least two witnesses who sign here:

Witness MYUNG SOO KIM
Witness YONG HO SON

LAW OFFICES OF JACOBSON, PRICE, HOLMAN & STERN THE JENIFER BUILDING 400 SEVENTH STREET, N.W. WASHINGTON, D.C. 20004